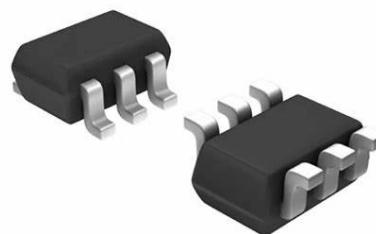


The SMF05C is a 5V TVS array, utilizing leading mono-lithic silicon technology to provide fast response time and low ESD clamping voltage, making this device an ideal solution for protecting voltage sensitive high-speed data lines. The SMF05C complies with the IEC 61000-4-2 (ESD) with  $\pm 30\text{kV}$  air and  $\pm 30\text{kV}$  contact discharge. It is assembled into a 6-Pin lead-free SOT-363 package. The low clamping voltage array make it ideal for use in portable electronics such as cell phones, PDAs, and digital cameras.



## Features

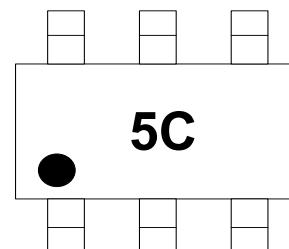
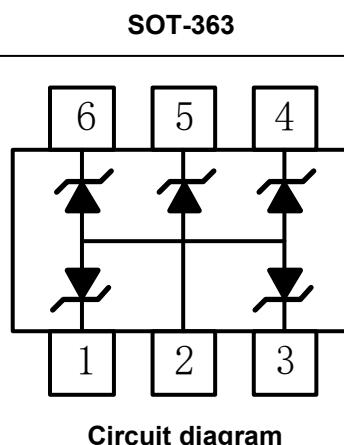
- Low leakage current
- Operating voltage: 5V
- Low clamping voltage
- JEDEC SOT-363 package
- Complies with following standards:
  - IEC 61000-4-2 (ESD) immunity test
    - Air discharge:  $\pm 30\text{kV}$
    - Contact discharge:  $\pm 30\text{kV}$
  - IEC61000-4-5 (Lightning) 3A (8/20 $\mu\text{s}$ )
- RoHS Compliant

## Mechanical Characteristics

- Package: SOT-363
- Lead Finish: Matte Tin
- Case Material: "Green" Molding Compound.
- Terminal Connections: See Diagram Below

## Applications

- Peripherals
- Industrial Equipment
- Notebook Computers
- Portable Instrumentation
- Microprocessor Based Equipment
- Cell Phone Handsets and Accessories
- Personal Digital Assistants (PDAs) and Pagers



5C = Device Marking Code  
Dot denotes Pin1  
**Marking (Top View)**

## Ordering Information

Part Number	Packaging	Reel Size
SMF05C	3000/Tape & Reel	7 inch

**Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$  unless otherwise specified)**

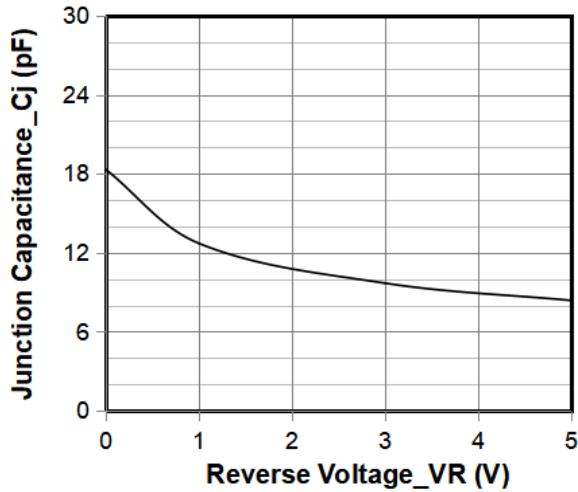
Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20μs)	Ppk	35	W
Peak Pulse Current (8/20μs)	IPP	3	A
ESD per IEC 61000-4-2 (Air)	VESD	±30	kV
ESD per IEC 61000-4-2 (Contact)		±30	
Operating Temperature Range	T <sub>J</sub>	-55 to +125	°C
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C

**Electrical Characteristics ( $T_A=25^\circ\text{C}$  unless otherwise specified)**

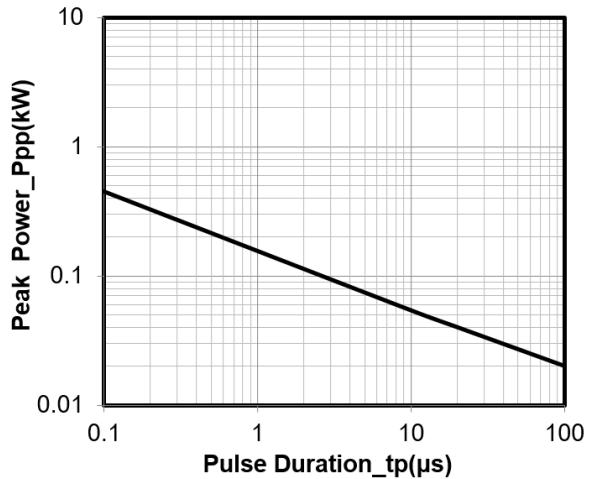
Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Working Voltage	V <sub>RWM</sub>			5	V	
Reverse Breakdown Voltage	V <sub>BR</sub>	6		8.5	V	I <sub>T</sub> = 1mA
Reverse Leakage Current	I <sub>R</sub>			0.2	μA	V <sub>RWM</sub> = 5V, any I/O pin to ground
Clamping Voltage	V <sub>C</sub>			9	V	IPP = 1A (8 x 20μs pulse), any I/O pin to ground
Clamping Voltage	V <sub>C</sub>			12	V	IPP = 3A (8 x 20μs pulse), any I/O pin to ground
Junction Capacitance	C <sub>J</sub>		20		pF	VR = 0V, f = 1MHz, any I/O pin to ground

Note 1: I/O pins are Pin 1, 3, 4, 5, 6

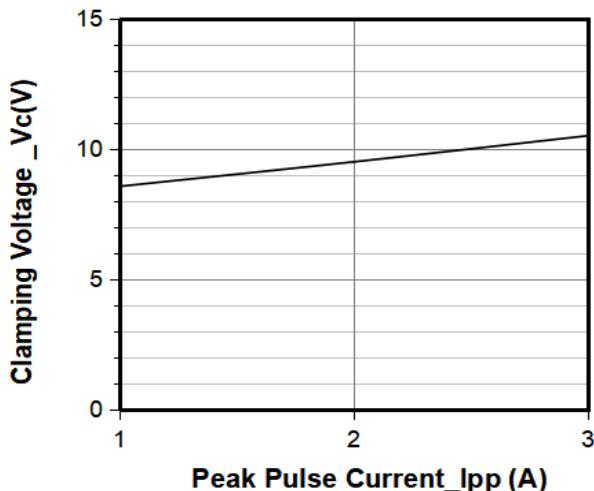
### Typical Performance Characteristics (TA=25°C unless otherwise Specified)



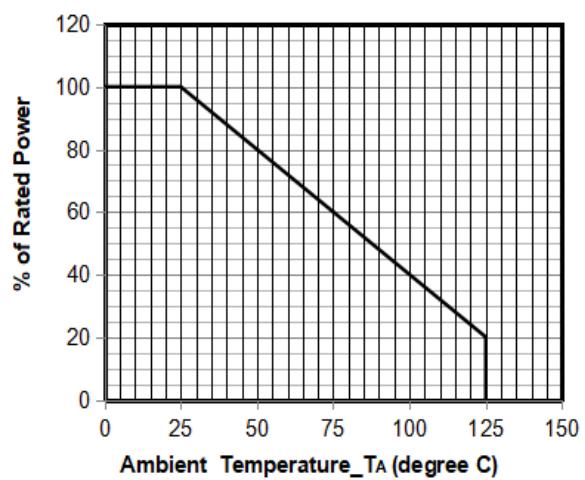
Junction Capacitance vs. Reverse Voltage



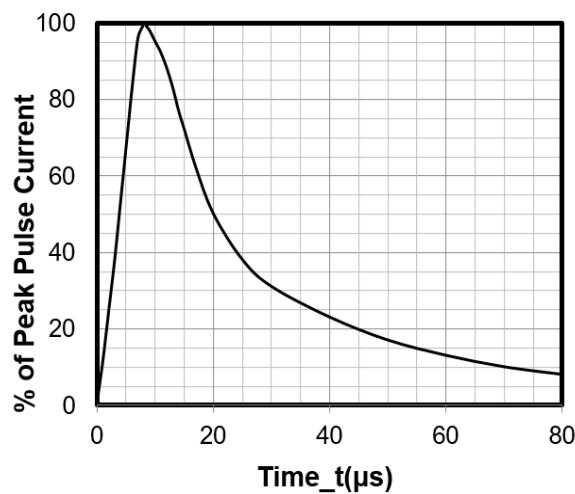
Peak Pulse Power vs. Pulse Time



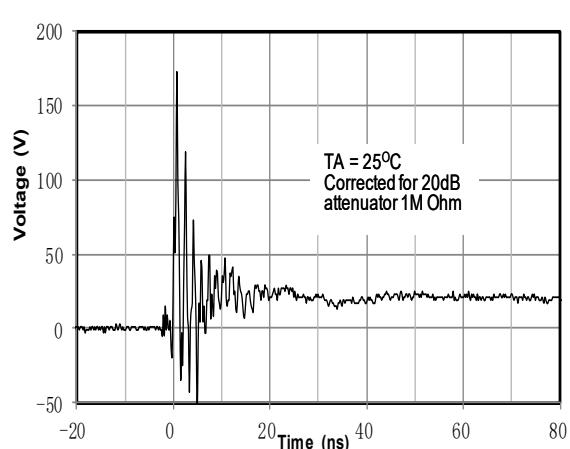
Clamping Voltage vs. Peak Pulse Current



Power Derating Curve



8 X 20μs Pulse Waveform



ESD Clamping Voltage

8 kV Contact per IEC61000-4-2